

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Ching-Lin Hsu	11/01/2006
RECEIVING PARTY DATA	
Name:	MediaTek Inc.
Street Address:	5F, No. 1-2, Innovation Road 1, Science-Based Industrial Park
City:	Hsin-Chu Hsien
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	11162465
CORRESPONDENCE DATA	
Fax Number:	(703)997-4517
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	3027291562
Email:	Patent.admin.uspto.cr@naipo.com
Correspondent Name:	WINSTON HSU
Address Line 1:	P.O.BOX 506
Address Line 4:	Merrifield, VIRGINIA 22116
ATTORNEY DOCKET NUMBER:	MTKP0284USA
NAME OF SUBMITTER:	WINSTON HSU
Total Attachments: 2 source=MTKP0284-0-Z3-1-ASS#page1.tif source=MTKP0284-0-Z3-1-ASS#page2.tif	

CH \$40.00 11162465

PATENT

Docket No MTKP0284USA

## ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

### ASSIGNOR(S) (Inventors):

Name: Ching-Lin Hsu Nationality: R.O.C.  
Address: No. 507-9, Chung-Shan Rd., Ching-Shui Town, Tai-Chung Hsien, Taiwan, R.O.C.

Hereby sells, assigns and transfers to

### ASSIGNEE(S):

Name: MediaTek Inc.  
Address: 5F, No.1-2, Innovation Road 1, Science-Based Industrial Park, Hsin-Chu Hsien, Taiwan

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

"Method and System for NAND-Flash Identification without Reading Device ID Table"

Which is found in :

- (a) \_\_\_\_\_ U.S. patent application executed on even date
- (b) \_\_\_\_\_ U.S. patent application executed on \_\_\_\_\_
- (c) ☒ U.S. application serial no. 11/162,465
- (d) \_\_\_\_\_ patent no. \_\_\_\_\_ issued \_\_\_\_\_

PATENT

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this NOV 01 2006 (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Signature of INVENTOR

Ching-Lin Hsu

Ching-Lin, Hsu